UNIVERSAL 8" COATING SYSTEM

RC8 GYRSET FOR TECHNOLOGY

ADVANCED SPIN COATING

The SUSS RC8 Spin Coater is based on the patented GYRSET® closed cover system. It combines state of the art technology with an innovative concept.

This unique design provides a better uniformity than conventional spin coaters. At the same time it significantly reduces resist consumption by up to 50% compared to conventional spin coating systems.

Better uniformity and less resist consumed make the SUSS RC8 spin coater the ideal tool from both financial and cost of ownership viewpoints.

The SUSS RC8 spin coater is extremely simple to operate, with fully programmable process parameters.

FEATURES AND BENEFITS

- Uses the GYRSET® closed cover spin coating system that offers uniform coatings with reduced consumption and less edge build-up particularly on square or rectangular substrates
- Microprocessor-based control system allows process parameters to be fully programmed with several process cycle and process steps
- Multi-size configuration with automatic GYRSET® cover size detection and automatic maximum spin speed limitation set up. It gives the flexibility to meet all major application types.



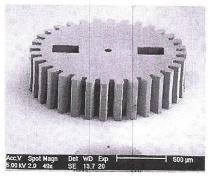
SUSS RC8 GYRSET® (with cabinet option)

- Handles up to 8 inch round or 6 inch square substrates
- Memory backup and RS232C interface for remote control
- High and low viscosity SUSS dispenser pump configuration with a single controller afford accurate and precise dispense of resist, solvent and polyimide
- GYRSET® quick exchange system and removable stainless steel collector bowl. It gives easy cleaning of the process chamber and the application of multiple chemically incompatible resists without danger of cross contamination
- Meets current SEMI-Spec ergonomic and safety requirements



GYRSET® - THE PATENTED SOLUTION

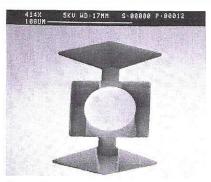
APPLICATIONS



Photoplastic gear, 450 μm high SU-8 resist Courtesy: SFIT (EPFL) and IBM (CH)

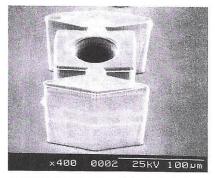
The SUSS RC 8 is capable of processing:

- Si and GaAs wafers and substrates
- Polyimide/SOG/adherence promoters
- Microsystem technology



Photoresist pattern of 57 µm thickness

- Rectangular substrates
- Flat panel display (passive, active, plasma, FED)
- Positive/negative photoresist
- Concave and convex lenses
- Photomasks
- A Photocells



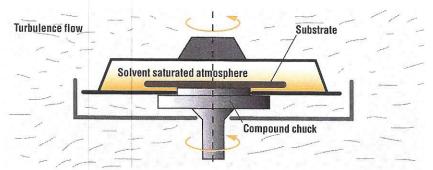
NiFe rotor element, 85 μm high, single shot coating

- Compact disks (ROM, audio, video)
- Glass mastering with thin layer coating
- Optical lenses, encoders, scales
- X ray masks
- Bumping applications for flip chip

THE GYRSET® SYSTEM

The patented SUSS GYRSET® system is based on a simple but revolutionary concept. Compared to a conventional spin coating system it

has multiple unparalleled advantages. The GYRSET® system offers better uniformity and up to 50% resist cost saving.



GYRSET® system design

The GYRSET® system with indexed bell-shaped cover excludes air turbulence inside the process chamber. This technique yields a uniform, consistent coating thickness without the usual spinning defects (no rebounding, no splashback, no striations, no comets, no corner effects).

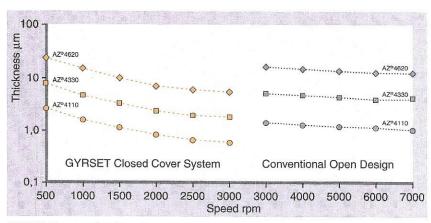
Because of the solvent-saturated atmosphere inside the process chamber, less resist dry skin effect occurs. Consequently, better uniformity and process control for thick as well as for thin resist layers are produced.



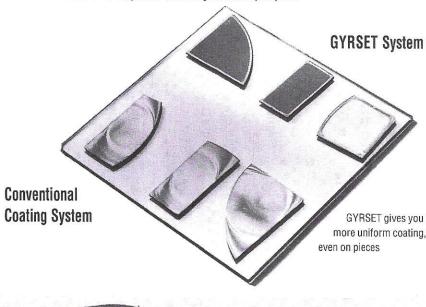
BENEFITS OF OWNERSHIP

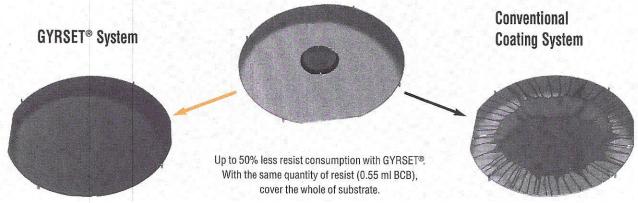
SUSS RC8 GYRSET® -A WISE INVESTMENT

- Reliable, consistent and uniform material application at lower spin speeds
- Economic ownership costs including lower resist consumption and reduced waste disposal expenses
- Service that is a cornerstone of our products and our reputation in the industry
- Highly reproducible thick resist applications
- Uniform coverage even over severe topography
- A wider range of resist thicknesses requiring fewer resist types
- Warranty backed by SUSS with multiple world-wide locations
- Technology unsurpassed in the industry today



GYRSET offers an order of magnitude wider range at lower spin speeds







GYRSET® CHOICES

7 000 rpm







RC8 GYRSET 5



RC8 GYRSET 8

Interchangeable GYRSET Systems for 3", 5" and 8" parts

MULTI-SIZE GYRSET®

The RC8 can be fitted with three different GYRSET® sizes: 3", 5" and 8". The configuration is automatically detected and the maximum speed set accordingly. With a change time of less than 5 minutes, the SUSS RC8 GYRSET® is the most flexible, upgradeable coater on the market.

FIXED AND QUICK EXCHANGE

Choose between a fixed or quick exchange GYRSET® plate. For ease of removal for cleaning, the quick exchange GYRSET® plate is simply locked by magnet to the hub. The hub is attached to the cover with two easy-access screws.

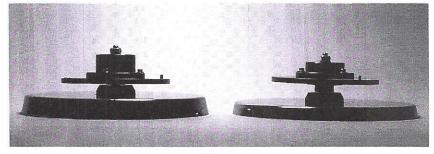


8" Quick Exchange GYRSET®

MULTI-PROFILE GYRSETS

Select the GYRSET® height according to the thickness of your substrate.
Use the table below to help you choose the correct size.

NOTE: For safety reasons, the high and extra high profile GYRSETS are only available with fixed hubs.



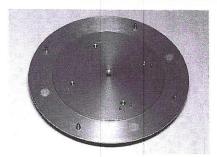
5" high profile and 5" standard profile GYRSETS

	STAND (Fixed for Quic		HI(ki T)	GH (ed)	EXTRA HIGH (Fixed)		
	Maximum Substrate Thickness (mm)	Maximum Spin Speed (rpm)	Maximum Substrate Thickness (mm)	Maximum Spin Speed (rpm)	Maximum Substrate Thickness (mm)	Maximum Spin Speed (rpm)	
RC8 GYRSET 8	4	3 000	12	3 000			
RC8 GYRSET 5	5	5 000	12	3 000	22	3 000	
RC8 GYRSET 3	5	7 000	12	3 000			



CONFIGURATION CHOICES

CHUCK CHOICES



3" Double Side Chuck



3" Single Side Chuck



3" Single Side Chuck with Adapter

DOUBLE SIDE AND SINGLE SIDE CHUCKS

Choose either double or single side chucks in 8", 5" or 3" sizes.

The substrates are vacuum-locked during processing .

The vacuum patterns, support pins and locating pins are designed according to your components and adapted to the options chosen.

ADAPTERS FOR SMALL PIECES

Available in both double and single side formats, these chucks allow you to process pieces up to 2" when the chuck is set up for larger sizes.

STANDARD PLATE

For safety reasons and to comply with EU regulations, the spin speed of the GYRSET is limited to 1000 rpm with the cover open. To solve this problem, SUSS offer a Standard Plate as an option to the GYRSET®. This system enables you to spin at high speeds, without the GYRSET effect. The GYRSET is simply replaced in the same way as changing between one GYRSET size and another.

Together with the standard plate, a range of three chucks is offered, depending on your requirements.

Outer	diam	eter (r	nm)
Inner			nm)
Wafer	size ((")	
Pin lif	t com	patibl	e
Adapt	er co	mpati	ble

818	819	824
120	120	120
80	45	88
4-8	2-4	4-8
No	No	Yes
No	Yes	No

NOTE: These chucks are single side only.

MODULAR OPTIONS

DISPENSER ARMS

The SUSS RC8 can be configured with multiple dispense capability dispenser arms, either pneumatic or motorised.

The PNEUMATIC DISPENSER ARM can be equipped with 2 resist lines and 2 solvent lines. The rest position and dispense position are factory adjusted.

The MOTORIZED DISPENSER ARM gives ultimate flexibility and the most sophisticated configuration.

With fully programmable speed and positioning, it can be fitted with up to 3 resist lines and 3 solvent lines. It is also required for the edge bead remover option and dynamic dispense with swing dispense process.



RC8 Cabinet rear showing separate exhausts



RC8 Cabinet with Motorised Arm and Resist Nozzle Autoclean Options

STAINLESS STEEL CABINET

Constructed of sturdy corrosion resistant stainless steel, it integrates the SUSS RC8 spin coater and options in a small footprint. The separate fluid storage, process area and electronics reduce the risk of contamination. A spill plate contains the liquids within the cabinet.

The upper safety barrier protects the operator and the additional flow grill provides laminar flow assuring proper ventilation through the process.

Easy installation is provided by the main connections at the back (nitrogen, vacuum, air, mains supply and exhausts).

PROGRAMMABLE SOLVENT DISPENSE

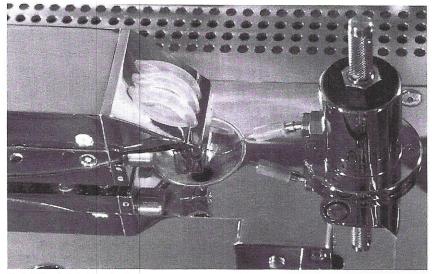
Includes a pressurized tank with Teflon® path and suck-back valve. Choose this option for spraying solvent for cleaning or developing and for adhesion promoter dispense.

PROGRAMMABLE AUTOCLEAN

Programs a cleaning cycle. The autocleaning frequency is set either with time (sec.) or number of cycles. Before starting cleaning, a bip signal and a message inform the user that a cleaning cycle is about to start. It gives the user time to remove the wafer/substrate from the chuck if the machine is already loaded.



MODULAR OPTIONS



Resist Nozzle Autoclean Option

RESIST NOZZLE AUTOCLEAN

This fully programmable option injects solvent into the required dispense pipe, dissolving any residue and cleaning the inside of the pipe.

When used in conjunction with the pump pre-dispense, it provides a highly effective solution to dispense contamination, eliminating unwanted particles.

CHUCK INDEXING AND SUBSTRATE LIFT UP/DOWN

Provides repeatable substrate loading positioning. At the end of the cycle the chuck is indexed and the substrate is lifted up, making loading and unloading easy.

NITROGEN BLOW

Releases a jet of nitrogen across your component before processing. Helps to remove any dust and dirt particles from the surface, thereby cleaning the component.

EDGE BEAD REMOVER

Removes the resist edge bead on round wafers and includes a pressurised tank with Teflon® path and suck-back valve. This requires the motorised dispenser arm option.

Fully programmable internal and external diameters, as well as dispense nozzle speed and solvent pressure, produce an optimum edge bead removing result.

COTTON CANDY REMOVER

This programmable solvent dispense includes a pressurised tank with Teflon® path and suck-back valve.

One of three dedicated solvents is programmed in the set up menu. Then, if selected during a spin cycle, it will dispense solvent onto the GYRSET® cover to remove strings ("cotton candy") and to clean the process chamber before the cycle stops.

This option gives excellent results and reduces substrate pollution due to cotton candy effects.

PHOTORESIST SWING NOZZLE

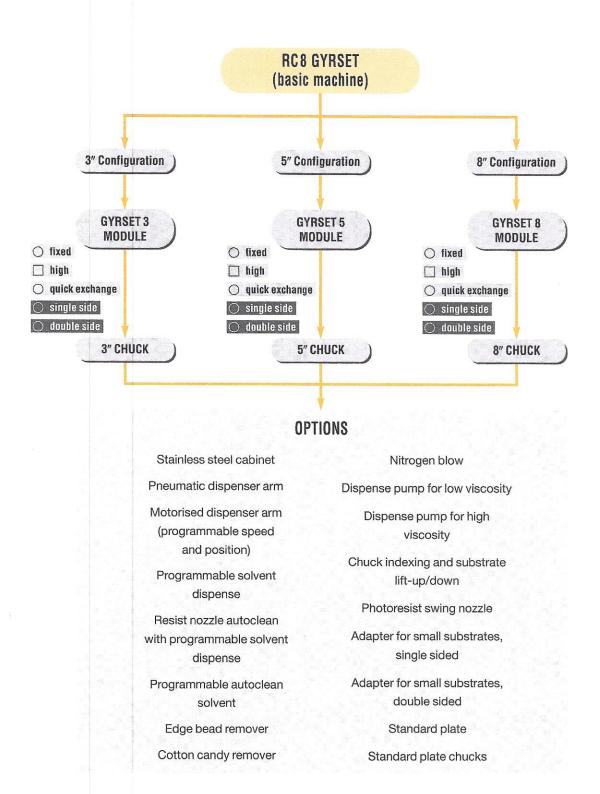
Dispenses a separate ring of photoresist on the wafer's internal or external edge. Gives a higher positional accuracy than the standard arm.



Edge Bead Remover and Swing Nozzle Options



CONFIGURATION



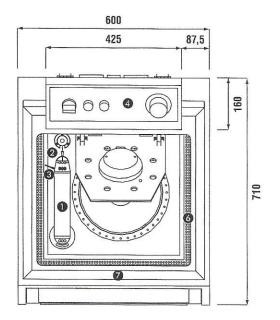


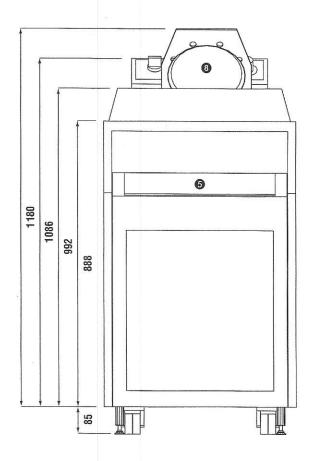
RC8

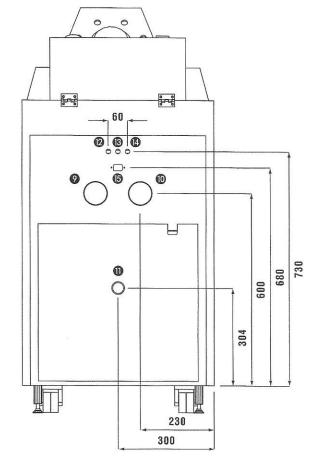
CABINET

- Motorised Arm Option
- Resist Nozzle Autoclean Option
- Edge Bead Remover Option
- 4 Isolation panel
- 6 Control panel
- 6 Flow grill
- Safety barrier
- GYRSET®
- Process chamber exhaust
- Upper cabinet exhaust
- Lower cabinet exhaust
- Compressed air
- Vacuum
- Mitrogen
- Mains supply

- 75 mm Ø
- 75 mm Ø
- 40 mm Ø
- 4-9 bar, 4 mm Ø
- -0.6 bar, 4 mm Ø
- 4-9 bar, 4 mm Ø
- 115 V/5 A or 230 V/2.5 A 0.3 kW







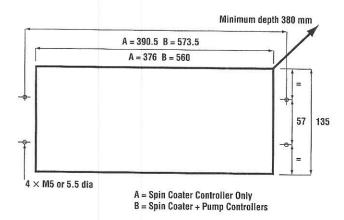


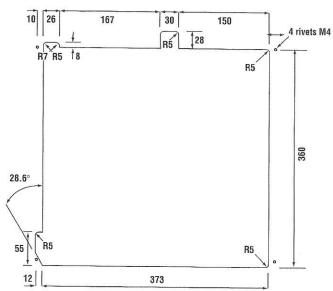
RC8

MECHANISM & INTEGRATION

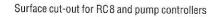
You may not have bought the cabinet option for your RC8 Spin Coater. In this case, you will need to integrate the mechanism, plus its controller, in a support.

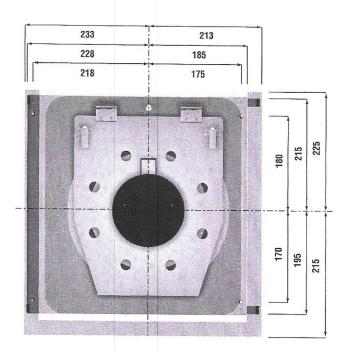
The following diagrams give the dimensions necessary for correct integration.

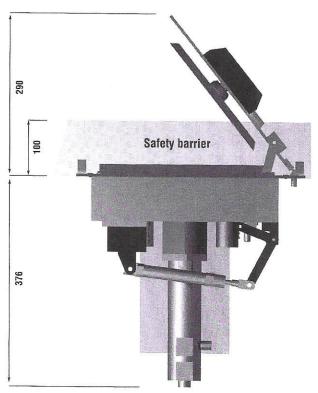




Surface cut-out for RC8 mechanism









TECHNICAL DATA: SUSS RC8 UNIVERSAL 8" GYRSET® SPIN COATER

Maximum Substrate Size	
RC8 GYRSET 3	up to 3" diagonal
RC8 GYRSET 5	up to 4" × 4"
	or 125 mm diagonal
RC8 GYRSET 8	up to $6'' \times 6''$
	or 200 mm diagonal
Maximum Speed (10 rpm	steps)
RC8 GYRSET 3	7 000 rpm
RC8 GYRSET 5	5 000 rpm
RC8 GYRSET 8	3 000 rpm
RC8 Standard Plate	7 000 rpm
Maximum Acceleration	5 000 rpm
Control	
Time Range	0-999 s
Speed Regulation	Tachometric
Speed Control	Galvanometric
Options	
Stainless Steel Cabinet	
Pneumatic Dispenser Arn	1
Motorised Dispenser Arm	
Programmable Solvent D	ispense
Resist Nozzle Autoclean v Solvent Dispense	vith Programmable
Programmable Autoclean	Solvent

Maximum Substrate Size

Programmable Autoclean Solvent Edge Bead Remover Cotton Candy Remover Nitrogen Blow Dispense Pump for Low Viscosity Dispense Pump for High Viscosity Chuck Indexing and Substrate Lift-Up/Down Photoresist Swing Nozzle Adapter for Small Substrates, Single Sided Adapter for Small Substrates, Double Sided

Utilities

-0.6 bar Vacuum Air pressure 4-9 bar Nitrogen 4-9 bar Exhaust 600 l/min

Power Requirements

Power AC 110/230 V Consumption 0.3 kW Frequency 47-63 Hz

Dimensions - Electronics Width × Depth × Height:

410 × 370 × 140 mm, 16.7" × 15.1" × 5.7" Weight 8 kg

Dimensions - Mechanics

Width × Depth × Height:

 $410 \times 410 \times 370$ mm, $16.7'' \times 16.7'' \times 15.1''$ Weight 14 kg

Dimensions - Cabinet (Option)

Footprint: $600 \text{ W} \times 720 \text{ mm D}$ $23.6" \times 28.3"$

Height 1000 mm, 40.8" 60 kg

Weight

Conforming to: European Machine Norms CE certification EMC Electro magnetic compatibility

SEMI Specifications

Data can depend on individual process conditions and will vary with equipment configuration.

Whatever your application, SUSS will help you find a solution. Our success is based on more than forty years of experience in production and research with a track record of proven quality.

SUSS. WHERE SOLUTIONS SET **STANDARDS**

KARL SUSS WORLDWIDE

GERMANY

KARL SÜSS KG · GmbH & Co. Schleissheimer Strasse 90 D-85748 Garching bei München Germany (+49) [0]89/32007-0

Fax (+49) [0]89/32007-162

FRANCE

KARL SUSS France SARL KARL SUSS Technique S.A. Avenue des Colombières F-74490 Saint Jeoire · France Tel (+33)-[0]4 50 35 83 92 Fax (+33)-[0]4 50 35 88 01

GREAT BRITAIN

KARL SUSS Great Britain Ltd. 23 Ivanhoe Road Hogwood Industrial Estate Finchampstead · Wokingham · Berkshire GB-RG40 4QQ · United Kingdom Tel (+44)-[0]1189-732144 Fax (+44)-[0]1189-734395

JAPAN

KARL SUSS Japan K. K. · Yokohama カール・ズース・ジャパン株式会社 〒226-0006 神奈川県横浜市緑区白山 1-18-2 ジャーマン・インダストリー・センター Tel (+81)-[0]45-931-5600, Fax -5601

ASIA

KARL SUSS Asia Co., Ltd. 212/2 Soi Ladprao 10 Ladprao Road, Ladyao - Jatujak Bangkok 10900 · Thailand Tel (+66) - 2 938 44 -26, -27 Fax (+66) - 25125569

NORTH AMERICA

KARL SUSS America Inc. P.O. Box 157. Suss Drive Waterbury Center - VT 05677 - USA Tel (+1) 802-244-5181, Fax -5103

INTERNET

http://www.suss.com

Representatives in over 30 countries. Please visit our web site for our address list.

